

## FDMS86369\_F085

# N-Channel PowerTrench<sup>®</sup> MOSFET 80 V, 65 A, 7.5 m $\Omega$

### **Features**

- Typical  $R_{DS(on)}$  = 5.9 m $\Omega$  at  $V_{GS}$  = 10V,  $I_D$  = 65 A
- Typical  $Q_{q(tot)}$  = 35 nC at  $V_{GS}$  = 10V,  $I_D$  = 65 A
- UIS Capability
- RoHS Compliant
- Qualified to AEC Q101

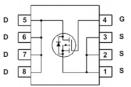
### **Applications**

- Automotive Engine Control
- PowerTrain Management
- Solenoid and Motor Drivers
- Integrated Starter/Alternator
- Primary Switch for 12V Systems





March 2015



For current package drawing, please refer to the Fairchild website at https://www.fairchildsemi.com/package-drawings/PQ/PQFN08M.pdf

### **MOSFET Maximum Ratings** T<sub>J</sub> = 25°C unless otherwise noted.

Symbol	Parameter		Ratings	Units
$V_{DSS}$	Drain-to-Source Voltage		80	V
$V_{GS}$	Gate-to-Source Voltage		±20	V
	Drain Current - Continuous (V <sub>GS</sub> =10) (Note 1)	T <sub>C</sub> = 25°C	65	۸
ID	Pulsed Drain Current	T <sub>C</sub> = 25°C	See Figure 4	A
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 2)	27	mJ
D	Power Dissipation		107	W
$P_D$	Derate Above 25°C		0.71	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature		-55 to +175	°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case		1.4	°C/W
$R_{\theta JA}$	Maximum Thermal Resistance, Junction to Ambient	(Note 3)	50	°C/W

### Notes

- 1: Current is limited by bondwire configuration.
- 2: Starting  $T_J = 25^{\circ}C$ , L = 20uH,  $I_{AS} = 52A$ ,  $V_{DD} = 80V$  during inductor charging and  $V_{DD} = 0V$  during time in avalanche.
- 3: R<sub>0,JA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>0,JC</sub> is guaranteed by design, while R<sub>0,JA</sub> is determined by the board design. The maximum rating presented here is based on mounting on a 1 in<sup>2</sup> pad of 2oz copper.

### **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86369	FDMS86369_F085	Power56	13"	12mm	3000units

Units

nΑ

Max.

±100

### **Electrical Characteristics** $T_J = 25^{\circ}C$ unless otherwise noted.

**Parameter** 

Gate-to-Source Leakage Current

Off Ch	Off Characteristics						
B <sub>VDSS</sub>	Drain-to-Source Breakdown Voltage	$I_D = 250 \mu A$	V <sub>GS</sub> = 0V	80	-	-	V
ı	Drain-to-Source Leakage Current	V <sub>DS</sub> =80V	$T_J = 25^{\circ}C$	-	-	1	μΑ
I <sub>DSS</sub> Drain-to-Source Leakage Current		\/oo = 0\/	$T_{1} = 175^{\circ}C \text{ (Note 4)}$	_	_	1	mΔ

 $V_{GS} = \pm 20V$ 

**Test Conditions** 

Min.

Тур.

### **On Characteristics**

Symbol

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 250\mu A$		2	3	4	V
D	Drain to Source On Resistance	I <sub>D</sub> = 65A,	$T_{J} = 25^{\circ}C$	-	5.9	7.5	mΩ
R <sub>DS(on)</sub> Drain to Source On Resistance	V <sub>GS</sub> = 10V	$T_J = 175^{\circ}C \text{ (Note 4)}$	-	12.2	15.5	mΩ	

### **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 40V, V <sub>GS</sub> = 0V, f = 1MHz		-	2470	-	pF
C <sub>oss</sub>	Output Capacitance			-	400	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1 - 1141112		-	14	-	pF
$R_g$	Gate Resistance	f = 1MHz		-	1.8	-	Ω
$Q_{g(ToT)}$	Total Gate Charge	V <sub>GS</sub> = 0 to 10V	V <sub>DD</sub> = 64V	-	35	46	nC
$Q_{g(th)}$	Threshold Gate Charge	$V_{GS} = 0 \text{ to } 2V$	I <sub>D</sub> = 65A	-	4.5	-	nC
$Q_{gs}$	Gate-to-Source Gate Charge		_	-	12.5	-	nC
$Q_{gd}$	Gate-to-Drain "Miller" Charge			-	8	-	nC

### **Switching Characteristics**

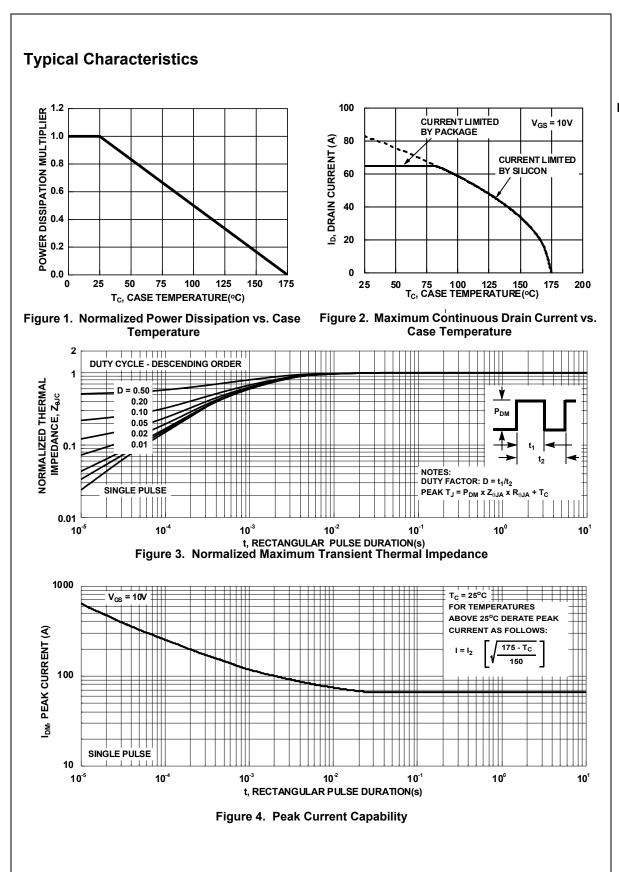
t <sub>on</sub>	Turn-On Time		-	-	39	ns
t <sub>d(on)</sub>	Turn-On Delay		-	15	-	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 40V, I <sub>D</sub> = 65A,	-	11	-	ns
t <sub>d(off)</sub>	Turn-Off Delay	$V_{GS}$ = 10V, $R_{GEN}$ = $6\Omega$	-	24	-	ns
t <sub>f</sub>	Fall Time		-	8	-	ns
t <sub>off</sub>	Turn-Off Time		-	-	48	ns

### **Drain-Source Diode Characteristics**

V	Source-to-Drain Diode Voltage	I <sub>SD</sub> =65A, V <sub>GS</sub> = 0V	-	-	1.4	V
$V_{SD}$	Source-to-Drain Diode Voltage	$I_{SD} = 32.5A, V_{GS} = 0V$	-	-	1.2	٧
t <sub>rr</sub>	Reverse-Recovery Time	I <sub>F</sub> = 65A, dI <sub>SD</sub> /dt = 100A/μs	-	49	74	ns
Q <sub>rr</sub>	Reverse-Recovery Charge	V <sub>DD</sub> = 64V	-	44	68	nC

### Note:

4: The maximum value is specified by design at  $T_J$  = 175°C. Product is not tested to this condition in production.



### **Typical Characteristics**

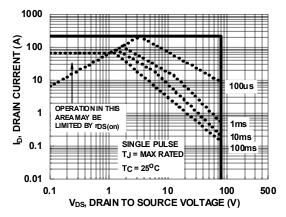
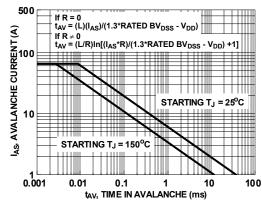


Figure 5. Forward Bias Safe Operating Area



NOTE: Refer to Fairchild Application Notes AN7514 and AN7515

Figure 6. Unclamped Inductive Switching

Capability

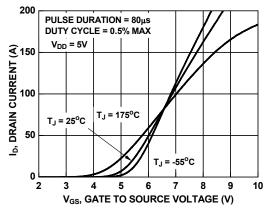


Figure 7. Transfer Characteristics

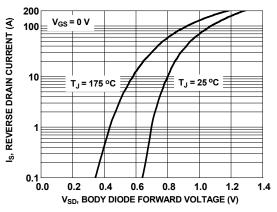


Figure 8. Forward Diode Characteristics

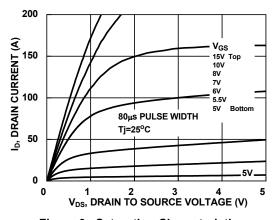


Figure 9. Saturation Characteristics

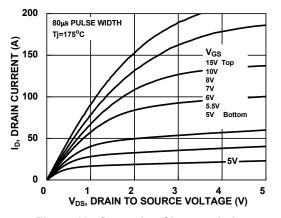


Figure 10. Saturation Characteristics

### **Typical Characteristics**

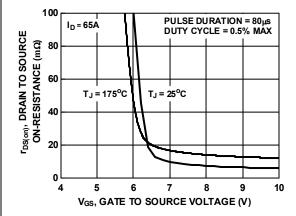


Figure 11. R<sub>DSON</sub> vs. Gate Voltage

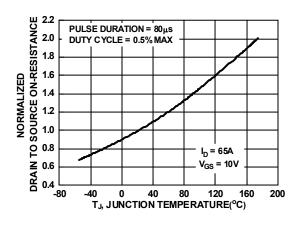


Figure 12. Normalized R<sub>DSON</sub> vs. Junction Temperature

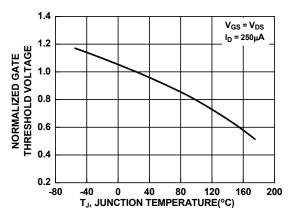


Figure 13. Normalized Gate Threshold Voltage vs. Temperature

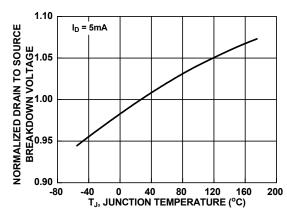


Figure 14. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

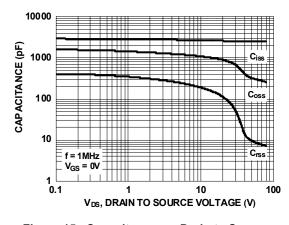


Figure 15. Capacitance vs. Drain to Source Voltage

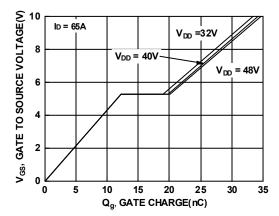


Figure 16. Gate Charge vs. Gate to Source Voltage





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